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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: : GROUP ART UNIT: 2815
RAVINDRANATH DROOPAD ET AL :
SERIAL NO.: 09/901,109 : EXAMINER: BAUMEISTER
FILED: JULY 10, 2001 :

FOR: STRUCTURE AND METHOD FOR FABRICATING SEMICONDUCTOR
STRUCTURES AND DEVICES UTILIZING THE FORMATION OF A COMPLIANT
SUBSTRATE COMPRISING AN OXYGEN-DOPED COMPOUND SEMICONDUCTOR
LAYER

RESTRICTION RESPONSE

ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231

SIR:

This is responsive to the Restriction Requirement dated January 7, 2003.

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REMARKS

The claims in this case were restricted into several Groups and Species. Applicants provisionally elect Group I, and Species IA, Claims 87-98 and 112-114 reading on, at least, Claims 1-13, 27-29, 87-98, 108 and 112-114.

The Office Letter characterizes the identified Groups of claims as being related, for example, as "process of making and product made." Referring to MPEP §806.05(f), the Office Letter takes the position that the product could be made by forming layers on temporary substrates followed by wafer-bonding. Separate utility in a certain device is provided as evidence of separate utility. While not taking a position with regard to the Examiner's comments, Applicants submit that the statements in the Office Letter do not meet the requirements set out in MPEP.

In this case there is no explanation in the Restriction Requirement as to why the